

LOCTITE ABLESTIK ABP 2024

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PRODUCT DESCRIPTION

LOCTITE ABLESTIK ABP 2024 provides the following product characteristics:

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Technology	BMI Hybrid	
Filler Type	Silica	
Product Benefits	Low outgassing	
	 One component 	
	 Non-conductive 	
	 High reliability 	
Cure	Heat cure	
Application	Die attach	
Typical Package	Image sensor device	
Application		

LOCTITE ABLESTIK ABP 2024 non-conductive paste is designed for image sensor die attach applications. It is formulated to have low outgassing at 260°C and eliminate contamination in cavity package applications requiring reflow.

TYPICAL PROPERTIES OF UNCURED MATERIAL

Viscosity, Brookfield CP51, 25 °C, mPa·s (cP):	
Speed 5 rpm	13,000
Thixotropic Index (0.5/5.0 rpm)	4.0
Density, g/cc	1.3
Work Life @ 25°C, hours	24
Shelf Life @ -40°C (from date of manufacture), days	365
Flash Point - See MSDS	

TYPICAL CURING PERFORMANCE

Cure Schedule

30 minute ramp to 175°C + 30 minutes @ 175°C

Alternative Cure Schedule

30 minutes @ 150°C

Weight Loss

Weight Loss @ 150°C, % 1.8

The above cure profile is a guideline recommendation. Cure conditions (time and temperature) may vary based on customers' experience and their application requirements, as well as customer curing equipment, oven loading and actual oven temperatures.

TYPICAL PROPERTIES OF CURED MATERIAL

Physical Properties

Glass Transition	Temperature,	°C:	
Tan ∆ Max			47
by TMA			-28

Coefficient of Thermal Expansion , TMA:			
Temperature Range: 0 to 50°C, ppm/°C		127	
Temperature Range: 150 to 200°C, ppm/°	C	156	
Extractable Ionic Content, @ 100°C for 24 h	ırs, ppm:		
Chloride (CI-)		<10	
Sodium (Na+)		<10	
Potassium (K+)		<10	
Weight Loss @ 150°C, %		1.8	
DMA Modulus :			
@ 25°C	N/mm² (psi)	510 (73,970)	
@ 100°C	N/mm²	160	
@ 150°C	(psi) N/mm² (psi)	(23,210) 120 (17,405)	
@ 200°C	N/mm² (psi)	` ' '	
@ 250°C	N/mm²	120	

Electrical Properties

Volume Resistivity, ohm-cm 4.7×10¹⁶

(psi)

(17,405)

Outgassing Properties

Outgassing , Sample cured 30 minutes @ 150°C, %:	
@ 150 °C	0
@ 200 °C	0
@ 260°C	0.4

TYPICAL PERFORMANCE OF CURED MATERIAL

Miscellaneous

Die Shear Strength :

2.0 X 2.0 mm (80 x 80 mil) Si die on Ag plated Cu LF, kg-f:

@ 25°C

@ 250°C

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GENERAL INFORMATION

For safe handling information on this product, consult the Material Safety Data Sheet, (MSDS).

THAWING:

- 1. Allow container to reach room temperature before use.
- 2. After removing from the freezer, set the syringes to stand vertically while thawing.
- DO NOT open the container before contents reach 25°C temperature. Any moisture that collects on the warmed up container should be removed prior to opening the container.
- DO NOT re-freeze. Once thawed, the adhesive should not be re-frozen.



DIRECTIONS FOR USE

- Thawed adhesive should immediately be placed on dispense equipment for use.
- If the adhesive is transferred to a final dispensing reservoir, care must be exercised to avoid entrapment of contaminants and/or air into the adhesive.
- Adhesive must be completely used within the products recommended work life.
- Apply enough adhesive to achieve a 25 to 50 µm wet bondline thickness, dispensed with approximately 25 to 50 % filleting on all sides of the die.
- 5. Alternate dispense amounts may be used depending on the application requirements.
- Star or crossed shaped dispense patterns will yield fewer bondline voids than the matrix style of dispense pattern.

Not for product specifications

The technical data contained herein are intended as reference only. Please contact your local quality department for assistance and recommendations on specifications for this product.

Storage

Store product in the unopened container in a dry location. Storage information may be indicated on the product container labeling.

Optimal Storage: -40 °C

Material removed from containers may be contaminated during use. Do not return product to the original container. Henkel Corporation cannot assume responsibility for product which has been contaminated or stored under conditions other than those previously indicated. If additional information is required, please contact your local Technical Service Center or Customer Service Representative.

Conversions

(°C x 1.8) + 32 = °F kV/mm x 25.4 = V/mil mm / 25.4 = inches N x 0.225 = lb N/mm x 5.71 = lb/in N/mm² x 145 = psi MPa x 145 = psi N·m x 8.851 = lb·in N·m x 0.738 = lb·ft N·mm x 0.142 = oz·in mPa·s = cP

Disclaimer

Note:

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